

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A liquid crystal device, comprising:
a pair of substrates;
a liquid crystal layer provided between the pair of substrates;
a sealing material bonding the pair of substrates to each other and enclosing the liquid crystal layer between the pair of substrates,
the sealing material containing a photocurable component and a thermosetting component, the photocurable component having a maximum curing rate in the range of from 60% to 95%, and the thermosetting component having a curing rate in the range of from 60% to 90%; and
~~a member~~at least one of a color filter and a metal wire disposed at a position corresponding to the sealing material, the ~~member~~at least one of a color filter and a metal wire at least partially blocking ultraviolet rays so that the photocurable component at portions of the sealing material that correspond to the ~~member~~at least one of a color filter and a metal wire has a curing rate of less than 60%.
2. (Previously Presented) The liquid crystal device according to Claim 1, the sealing material including a resin containing the photocurable component and the thermosetting component in the same molecular chain.
3. (Previously Presented) The liquid crystal device according to Claim 1, the sealing material including a resin containing the photocurable component, a resin containing the thermosetting component, and a resin containing the photocurable component and the thermosetting component in the same molecular chain.

4. (Previously Presented) The liquid crystal device according to Claim 1, the photocurable component including at least one of an acrylic group and a methacrylic group.

5. (Previously Presented) The liquid crystal device according to Claim 1, the thermosetting component including an epoxy group.

6. (Currently Amended) A method for manufacturing a liquid crystal device ~~having~~including a pair of substrates, a liquid crystal layer provided between ~~a~~the pair of substrates, an adhesive framing the liquid crystal layer, and at least one of a color filter and a metal wire that at least partially blocks ultraviolet light rays, the method comprising:

applying ~~an~~the adhesive onto at least one of surfaces of the pair of substrates to form a closed frame shape in a region of the surface thereof;

disposing spacers on at least one of surfaces of the pair of substrates;

dripping liquid crystal onto at least one of surfaces of the pair of substrates after the adhesive and the spacers are disposed;

bonding the pair of substrates to each other after the liquid crystal is dripped;

curing the adhesive after the bonding is performed, the adhesive being an uncured material which is formed to a sealing material by curing, the sealing material containing a photocurable component and a thermosetting component, the photocurable component having a maximum curing rate in the range of from 60% to 95%, and the thermosetting component having a curing rate in the range of from 60% to 90%; and

disposing ~~a member~~the at least one of a color filter and a metal wire at a position corresponding to the sealing material, the ~~member~~at least one of a color filter and a metal wire at least partially blocking ultraviolet rays so that the photocurable component at portions of the sealing material that correspond to the ~~member~~at least one of a color filter and a metal wire has a curing rate of less than 60%.

7. (Currently Amended) A method for manufacturing a liquid crystal device ~~having~~including a pair of substrates, a liquid crystal layer provided between the pair of substrates, an adhesive framing the liquid crystal layer, and at least one of a color filter and a metal wire that at least partially blocks ultraviolet light rays, the method comprising:

- applying ~~an~~the adhesive onto at least one of surfaces of the pair of substrates to form a frame shape provided with a liquid crystal inlet;
- disposing spacers on at least one of surfaces of the pair of substrates;
- bonding the pair of substrates to each other after the adhesive and the spacers are disposed;
- curing the adhesive after the bonding is performed;
- injecting liquid crystal inside the adhesive through the liquid crystal inlet, the adhesive being an uncured material which is formed to a sealing material by curing, the sealing material containing a photocurable component and a thermosetting component, the photocurable component having a maximum curing rate in the range of from 60% to 95%, and the thermosetting component having a curing rate in the range of from 60% to 90%; and
- disposing ~~a member~~the at least one of a color filter and a metal wire at a position corresponding to the sealing material, ~~the member~~at least one of a color filter and a metal wire at least partially blocking ultraviolet rays so that the photocurable component at portions of the sealing material that correspond to the ~~member~~at least one of a color filter and a metal wire has a curing rate of less than 60%.

8. (Previously Presented) The method for manufacturing a liquid crystal device according to Claim 6, the curing of the adhesive including a light irradiation substep of curing the photocurable component, and the amount of light irradiation in the light irradiation substep being 1,000 to 6,000 mJ/cm².

9. (Previously Presented) The method for manufacturing a liquid crystal device according to Claim 6, the curing of the adhesive including a heating substep of curing the thermosetting component, and the heating temperature and the heating time in the heating substep being set to 60 to 160°C and 20 to 300 minutes, respectively.

10. (Previously Presented) An electronic apparatus, comprising:

the liquid crystal device according to Claim 1.

11. (Canceled).